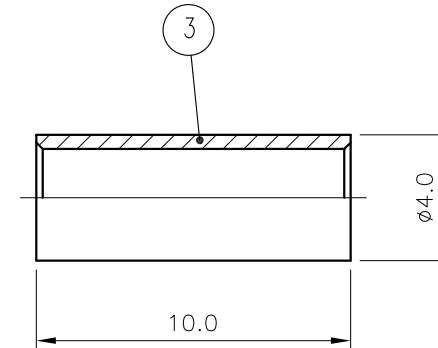
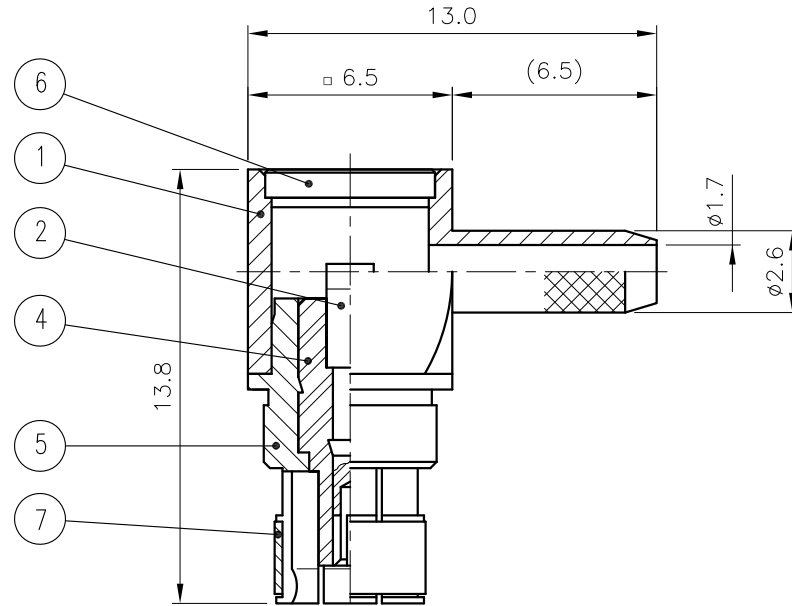
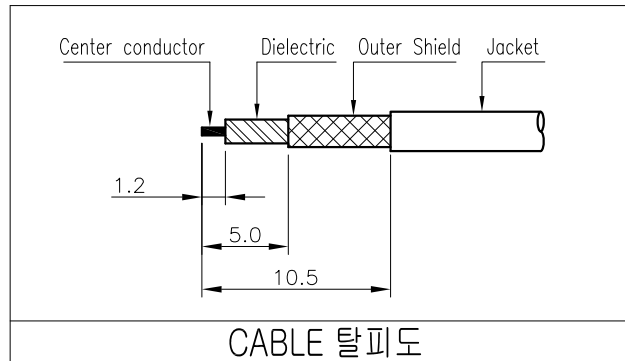


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM		2018.12.17.
i	[설번No.202203-0008] PIPE 공용화 부품 적용으로 인한 코드 변경	S.Y.EUN	S.H.KIM	2022.03.15.

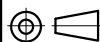


조립 주의 사항

-CABLE 삽입부 내경 $\phi 1.7$ 후가공 가공여부 확인후 조립할것



7	SPRING RING	1	BeCu C17300	Gold Plate	DSR00004-5/1
6	COVER	1	MBsBD C3604BD-F	산무 Gold Plate	DCO00036-5/2
5	JACK	1	MBsBD C3604BD-F	산무 Gold Plate	DJA00034-5/3
4	INSULATOR	1	TEFLON		DIN00342-N/1
3	FERRULE	1	MBsBD C3604BD-F	Nickel Plate Gold Plate	DFE00034-5/1 DFE00031-5/1
2	CONTACT	1	BeCu C17300	Gold Plate	DCT00358-5/1
1	BODY	1	MBsBD C3604BD-F	산무 Gold Plate	DBD00451-5/3
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ± 0.2	DATE 2022. 03. 15.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle $\pm 1^{\circ}$	APPROVED BY	S.H.KIM		
MATERIAL		CHECKED BY		TITLE SMB50 CABLE PL RG316	
FINISH		DRAWN BY	S.Y.EUN		
SCALE 4/1		UNIT mm		DWG NO. CN00207-7/3	SHEET 1 of 1
				REVISION 1	